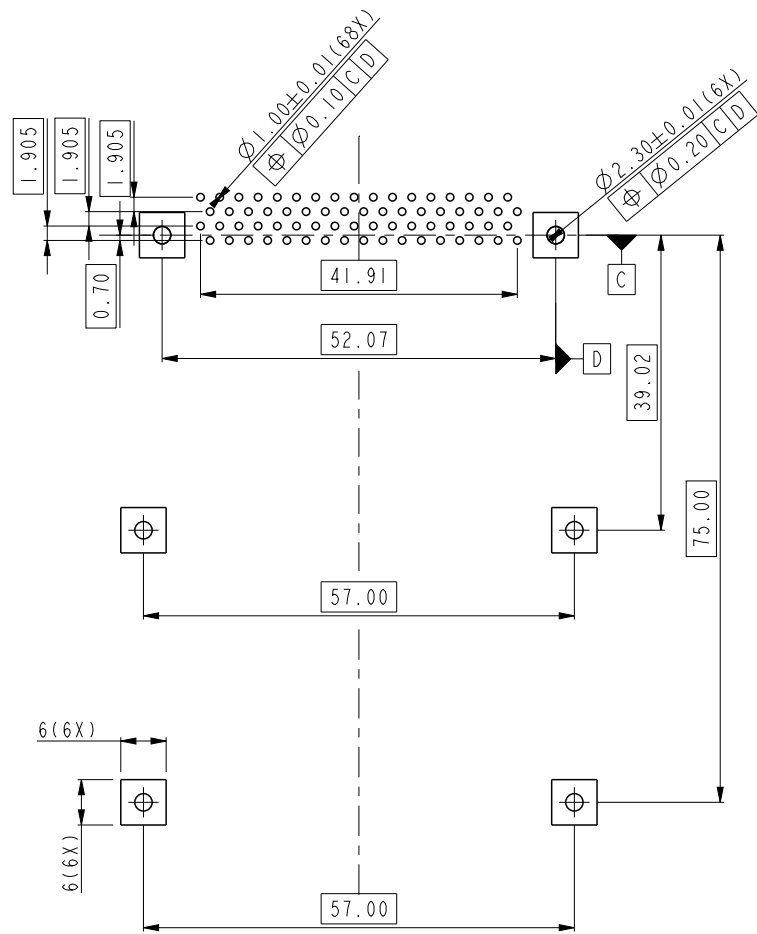
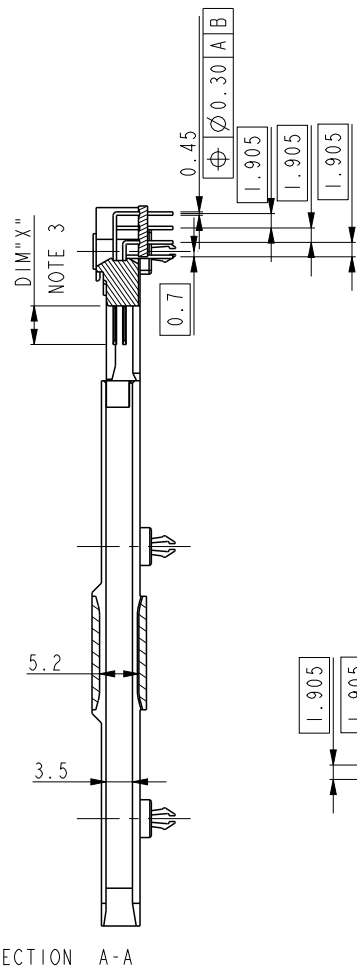
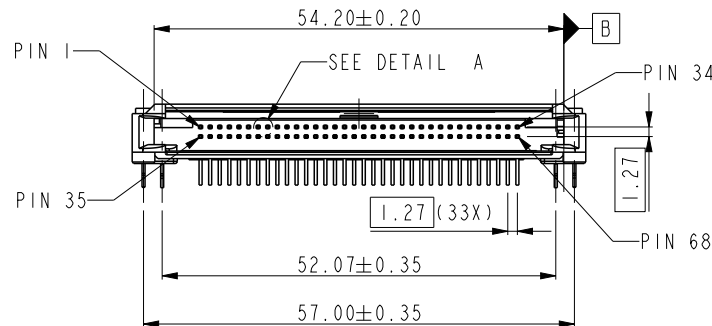
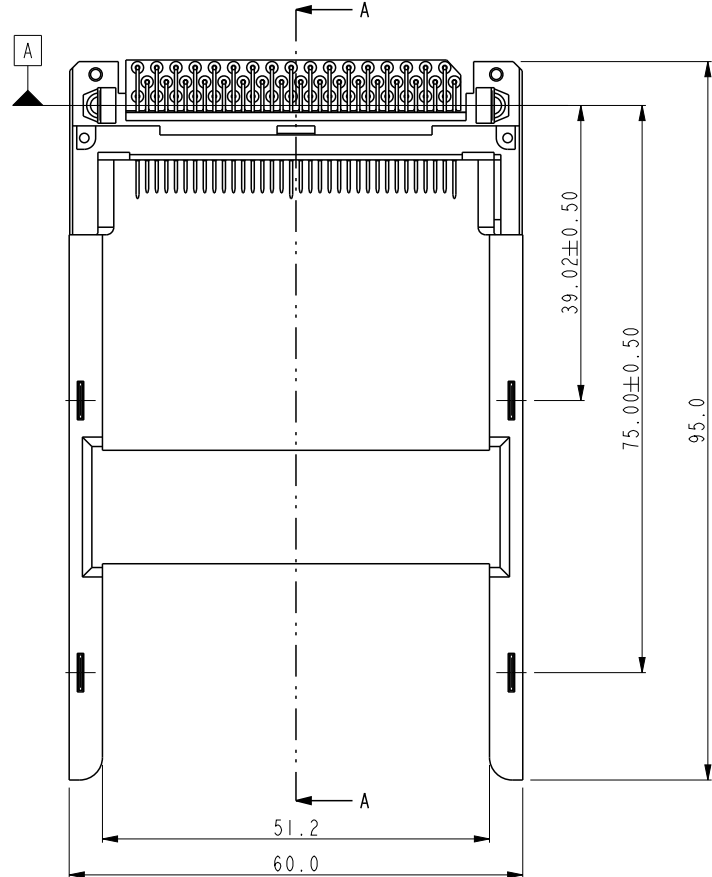
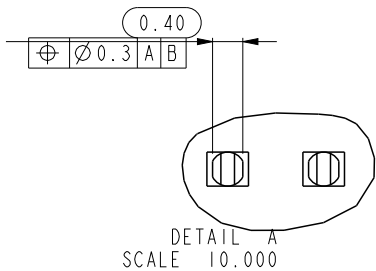
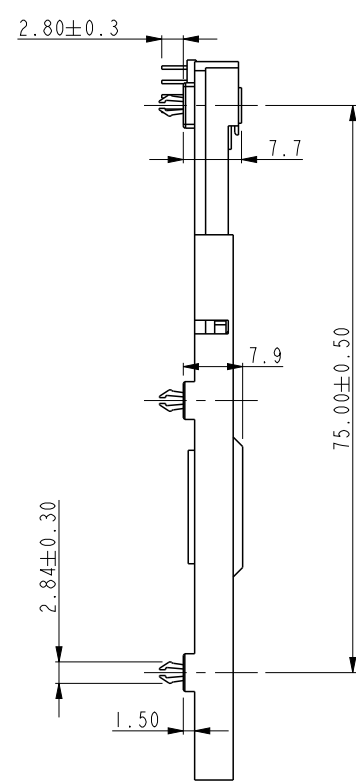


PRODUCT NUMBER	STAND OFF
10120751-015LF	1.5MM



- NOTES:
- MATERIAL:
HOUSING : HIGH TEMPERATURE THERMOPLASTIC,
UL94-V0 BLACK.
PIN: COPPER ALLOY
 - FINISH(PIN)
2-1. Ni UNDER PLATING 1.27MM THICKNESS MIN. ALL OVER
2-2. 0.076uM Au MIN. AT CONTACT AREA
2-3. PURE TIN PLATING 2.5uM THICKNESS MIN.
 - | PIN NUMBER | OTHERS | 36,37 | 1,17,34,35,51,68 |
|------------|----------|---------|------------------|
| DIM"X" | 4.25±0.1 | 3.5±0.1 | 5.0±0.1 |
 - THIS PART WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECOND IN A WAVE SOLDER APPLICATION WITH 1.60MM MINIMUM THICK CIRCUIT BOARD.
 - THIS PART MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008
 - PRODUCT SPEC: 110-263.

spec ref		-		dr		Zheng-Kun Hu		2013/03/12		projection				MM		size		A3		scale		1.000	
tolerance std		TOLERANCES UNLESS OTHERWISE SPECIFIED		eng		Zheng-Kun Hu		2013/03/13						ecn no		-							
ISO 406				chr		-		-															
ISO 1101				appr		Rick Bian		2013/03/13						product family		-		rel level		Released			
surface		linear		0.X		±0.3				title		68POS 3.3V PCMCIA ASSEMBLY		dwg no		10120751		rev		A			
				0.XX		±0.20																	
				0.XXX		±0.10																	
ISO 1302		angular		0°		±2°		www.fci.com		cat. no.		-		Product - Customer Drw		sheet 1 of 1							